

2.0x1.25mm SMD CHIP LED LAMP

PRELIMINARY SPEC



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE

DEVICES

Part Number: KPHCM-2012VGC-A

Features

- 2.0X1.25mm SMT LED,0.5mm MAX.THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE: 2000PCS/REEL.
- MOISTURE SENSITIVITY LEVEL: LEVEL 3.
- RoHS COMPLIANT.

Description

The Green source color devices are made with InGaN on G-SiC Light Emitting Diode.

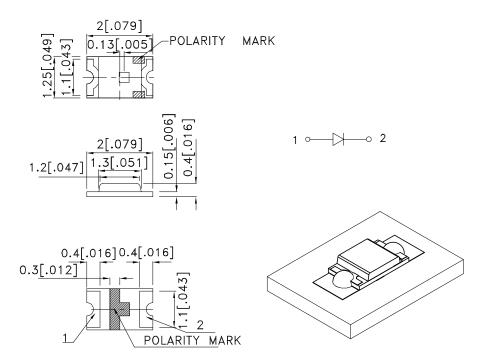
Green

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1 (0.004")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.4. The device has a single mounting surface. The device must be mounted according to the specifications.





PAGE: 1 OF 4 SPEC NO: DSAH1251 **REV NO: V.2** DATE: JUL/02/2007 APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Y.L.LI ERP: 1203005674

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		,	Min.	Тур.	201/2
KPHCM-2012VGC-A	Green (InGaN)	WATER CLEAR	50	180	110°

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	520		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	525		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	35		nm	IF=20mA
С	Capacitance	Green	100		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	3.2	4	V	IF=20mA
IR	Reverse Current	Green		10	uA	V _R =5V

- 1.Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

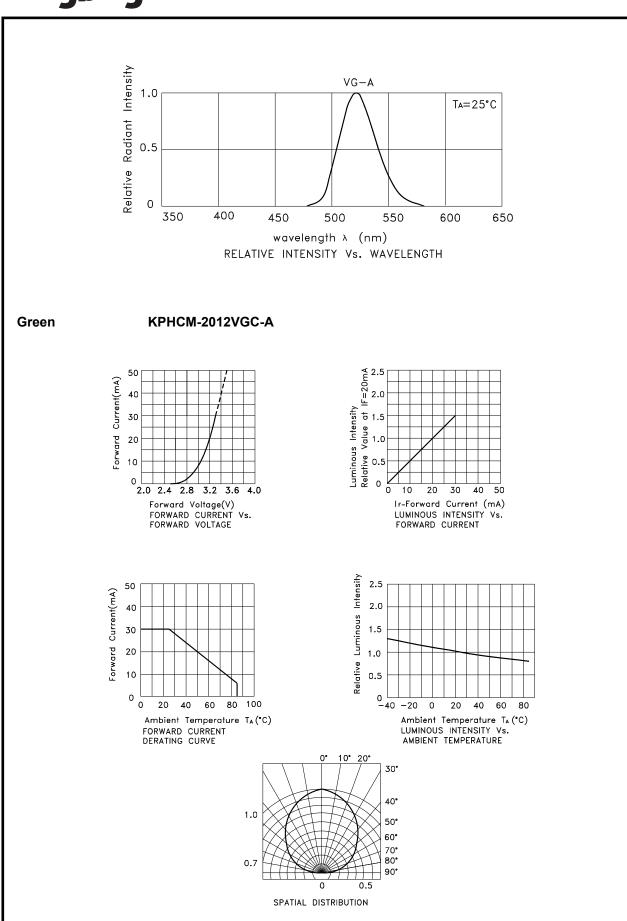
Parameter	Green	Units		
Power dissipation	120	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	100	mA		
Reverse Voltage	5	V		
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

SPEC NO: DSAH1251 REV NO: V.2 DATE: JUL/02/2007 PAGE: 2 OF 4 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.L.LI ERP: 1203005674

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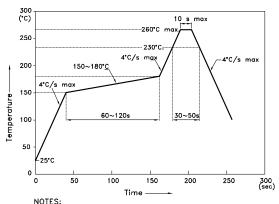
 SPEC NO: DSAH1251
 REV NO: V.2
 DATE: JUL/02/2007
 PAGE: 3 OF 4

 APPROVED: WYNEC
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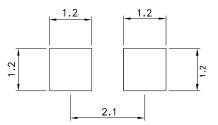
Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

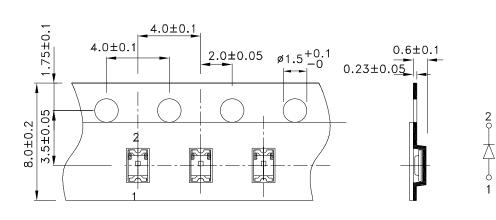
 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Specifications (Units: mm)

TAPE



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PAGE: 4 OF 4 ERP: 1203005674